



# BC847xMB series

45 V, 100 mA NPN general-purpose transistors

Rev. 1 — 5 March 2012

Product data sheet

## 1. Product profile

### 1.1 General description

NPN general-purpose transistors in a leadless ultra small SOT883B Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

| Type number | Package  |       |       | PNP complement |
|-------------|----------|-------|-------|----------------|
|             | Nexperia | JEITA | JEDEC |                |
| BC847AMB    | SOT883B  | -     | -     | BC857AMB       |
| BC847BMB    | SOT883B  | -     | -     | BC857BMB       |
| BC847CMB    | SOT883B  | -     | -     | BC857CMB       |

### 1.2 Features and benefits

- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Power dissipation comparable to SOT23
- AEC-Q101 qualified

### 1.3 Applications

- General-purpose switching and amplification
- Mobile applications

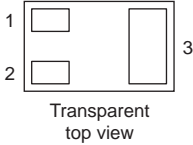
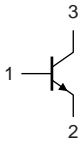
### 1.4 Quick reference data

Table 2. Quick reference data

| Symbol    | Parameter                 | Conditions                               | Min | Typ | Max | Unit |
|-----------|---------------------------|--|-----|-----|-----|------|
| $V_{CE0}$ | collector-emitter voltage | open base                                | -   | -   | 45  | V    |
| $I_C$     | collector current         |  | -   | -   | 100 | mA   |
| $h_{FE}$  | DC current gain           | $V_{CE} = 5\text{ V}; I_C = 2\text{ mA}$ |     |     |     |      |
|           | BC847AMB                  |  | 110 | -   | 220 |      |
|           | BC847BMB                  |  | 200 | -   | 450 |      |
|           | BC847CMB                  |  | 420 | -   | 800 |      |

## 2. Pinning information

Table 3. Pinning

| Pin | Description | Simplified outline  | Graphic symbol  |
|-----|-------------|---|---|
| 1   | base        |  <p>Transparent top view</p> |  <p>sym021</p> |
| 2   | emitter     |   |   |
| 3   | collector   |   |   |

## 3. Ordering information

Table 4. Ordering information

| Type number       | Package |  |         |
|-------------------|---------|--|---------|
|                   | Name    | Description  | Version |
| BC847xMB series - | -       | leadless ultra small plastic package; 3 solder lands; body 1.0 × 0.6 × 0.37 mm | SOT883B |

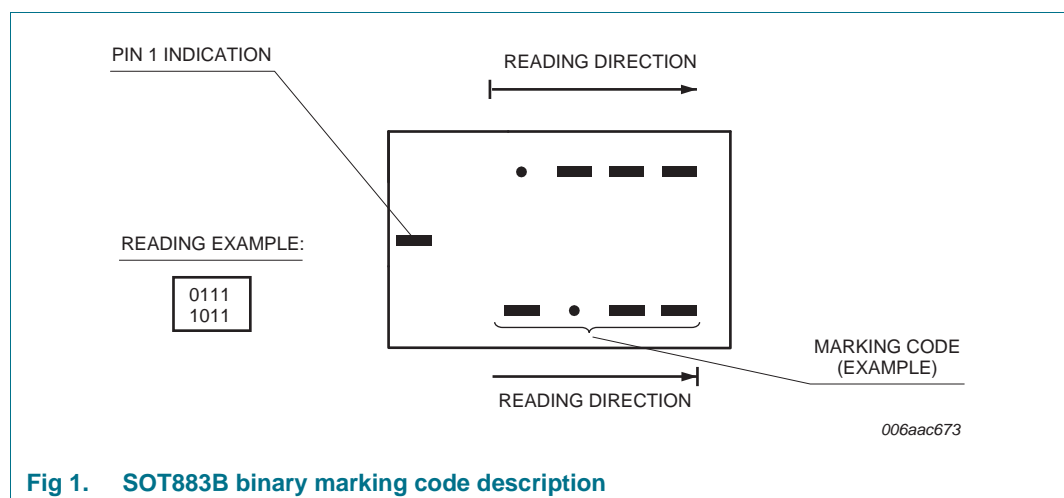
## 4. Marking

Table 5. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| BC847AMB    | 0100 0001                   |
| BC847BMB    | 0100 0010                   |
| BC847CMB    | 0100 0011                   |

[1] For SOT883B binary marking code description, see [Figure 1](#).

### 4.1 Binary marking code description



## 5. Limiting values

**Table 6. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol    | Parameter                 | Conditions                       | Min      | Max  | Unit |
|-----------|---------------------------|----------------------------------|----------|------|------|
| $V_{CBO}$ | collector-base voltage    | open emitter                     | -        | 50   | V    |
| $V_{CEO}$ | collector-emitter voltage | open base                        | -        | 45   | V    |
| $V_{EBO}$ | emitter-base voltage      | open collector                   | -        | 6    | V    |
| $I_C$     | collector current         |                                  | -        | 100  | mA   |
| $I_{CM}$  | peak collector current    | single pulse;<br>$t_p \leq 1$ ms | -        | 200  | mA   |
| $I_{BM}$  | peak base current         | single pulse;<br>$t_p \leq 1$ ms | -        | 100  | mA   |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25$ °C             | [1][2] - | 250  | mW   |
| $T_j$     | junction temperature      |                                  | -        | 150  | °C   |
| $T_{amb}$ | ambient temperature       |                                  | -55      | +150 | °C   |
| $T_{stg}$ | storage temperature       |                                  | -65      | +150 | °C   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

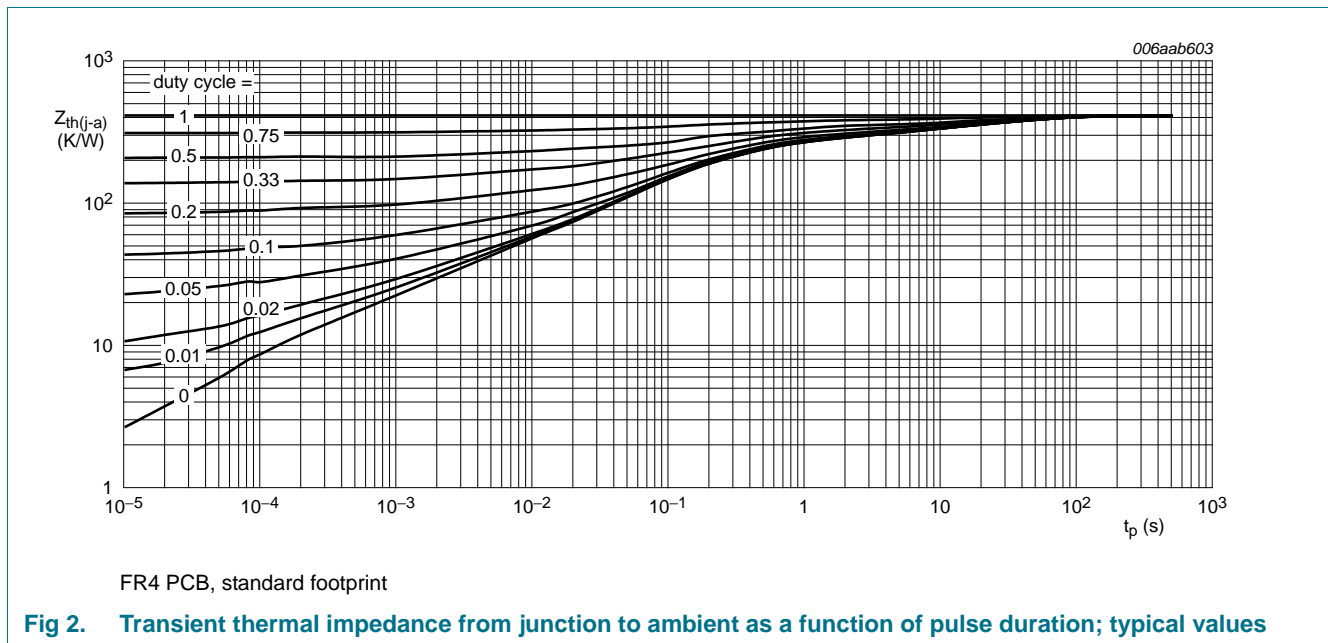
## 6. Thermal characteristics

**Table 7. Thermal characteristics**

| Symbol        | Parameter                                   | Conditions  | Min      | Typ | Max | Unit |
|---------------|---|-------------|----------|-----|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1][2] - | -   | 500 | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.



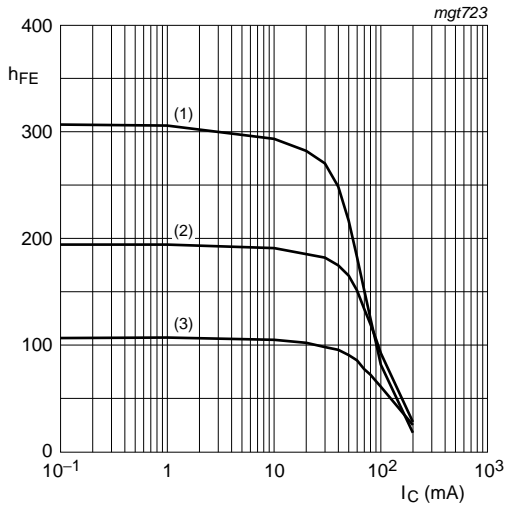
**Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values**

## 7. Characteristics

**Table 8. Characteristics**
 $T_{amb} = 25\text{ °C}$  unless otherwise specified.

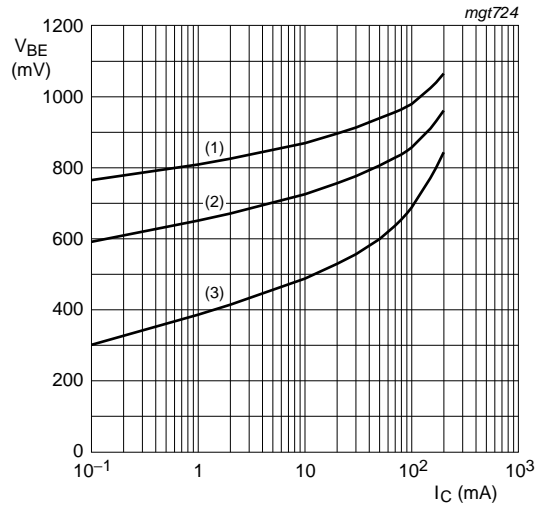
| Symbol      | Parameter                            | Conditions   | Min      | Typ | Max | Unit          |    |
|-------------|--------------------------------------|--|----------|-----|-----|---------------|----|
| $I_{CBO}$   | collector-base cut-off current       | $V_{CB} = 30\text{ V}; I_E = 0\text{ A}$   | -        | -   | 15  | nA            |    |
|             |                                      | $V_{CB} = 30\text{ V}; I_E = 0\text{ A}; T_j = 150\text{ °C}$  | -        | -   | 5   | $\mu\text{A}$ |    |
| $I_{EBO}$   | emitter-base cut-off current         | $V_{EB} = 5\text{ V}; I_C = 0\text{ A}$  | -        | -   | 100 | nA            |    |
| $h_{FE}$    | DC current gain                      | $V_{CE} = 5\text{ V}; I_C = 2\text{ mA}$   |          |     |     |               |    |
|             |                                      |  | BC847AMB | 110 | -   | 220           |    |
|             |                                      |  | BC847BMB | 200 | -   | 450           |    |
|             |                                      |  | BC847CMB | 420 | -   | 800           |    |
| $V_{CEsat}$ | collector-emitter saturation voltage | $I_C = 10\text{ mA}; I_B = 0.5\text{ mA}$  | -        | 90  | 200 | mV            |    |
|             |                                      | $I_C = 100\text{ mA}; I_B = 5\text{ mA}$   | [1]      | -   | 200 | 400           | mV |
| $V_{BEsat}$ | base-emitter saturation voltage      | $I_C = 10\text{ mA}; I_B = 0.5\text{ mA}$  | -        | 700 | -   | mV            |    |
|             |                                      | $I_C = 100\text{ mA}; I_B = 5\text{ mA}$   | [1]      | -   | 900 | -             | mV |
| $V_{BE}$    | base-emitter voltage                 | $I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$   | 580      | 660 | 700 | mV            |    |
|             |                                      | $I_C = 10\text{ mA}; V_{CE} = 5\text{ V}$  | -        | -   | 770 | mV            |    |
| $f_T$       | transition frequency                 | $V_{CE} = 5\text{ V}; I_C = 10\text{ mA}; f = 100\text{ MHz}$  | 100      | -   | -   | MHz           |    |
| $C_c$       | collector capacitance                | $V_{CB} = 10\text{ V}; I_E = I_C = 0\text{ A}; f = 1\text{ MHz}$   | -        | -   | 1.5 | pF            |    |
| $C_e$       | emitter capacitance                  | $V_{EB} = 0.5\text{ V}; I_C = I_E = 0\text{ A}; f = 1\text{ MHz}$  | -        | 11  | -   | pF            |    |
| NF          | noise figure                         | $I_C = 200\text{ }\mu\text{A}; V_{CE} = 5\text{ V}; R_S = 2\text{ k}\Omega; f = 1\text{ kHz}; B = 200\text{ Hz}$ | -        | 2   | 10  | dB            |    |

[1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$ .



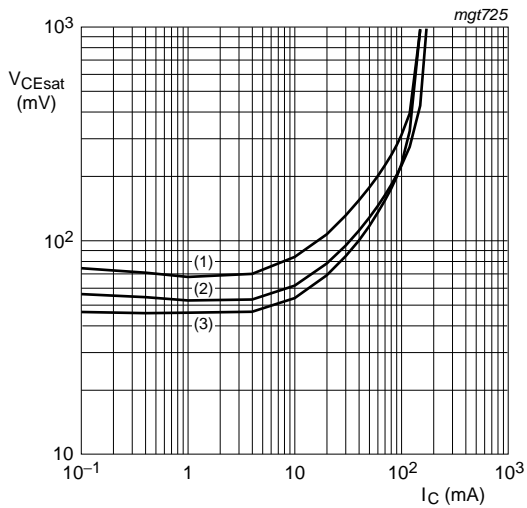
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 3. BC847AMB: DC current gain as a function of collector current; typical values**



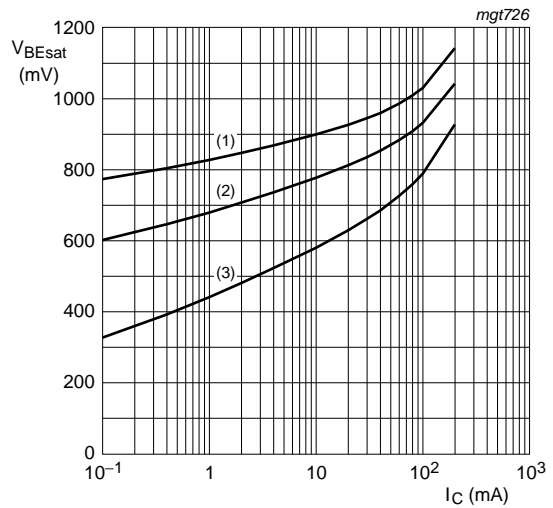
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 4. BC847AMB: Base-emitter voltage as a function of collector current; typical values**



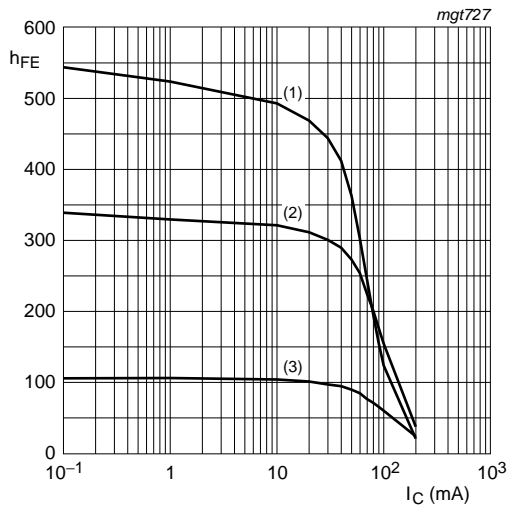
$I_C/I_B = 20$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 5. BC847AMB: Collector-emitter saturation voltage as a function of collector current; typical values**



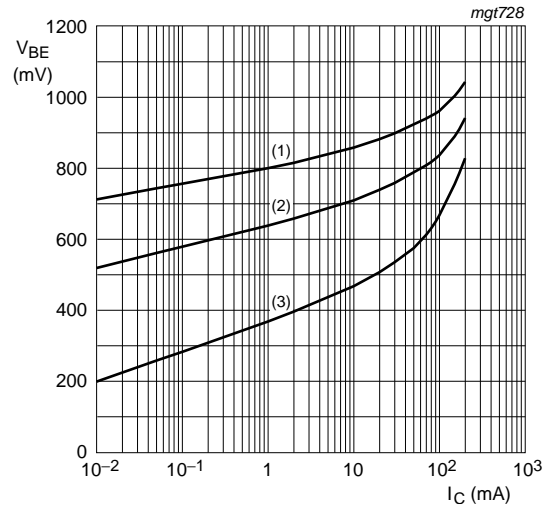
$I_C/I_B = 10$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 6. BC847AMB: Base-emitter saturation voltage as a function of collector current; typical values**



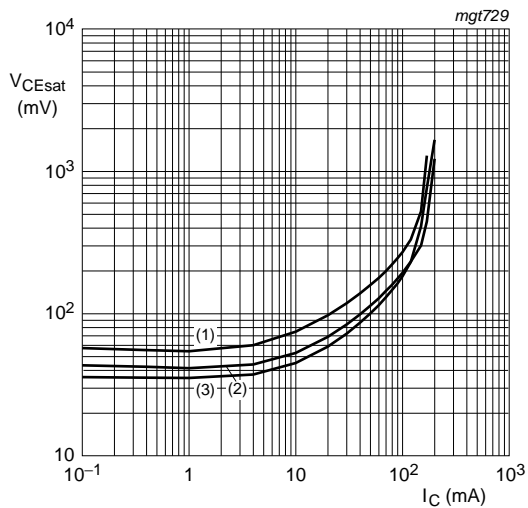
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 7. BC847BMB: DC current gain as a function of collector current; typical values**



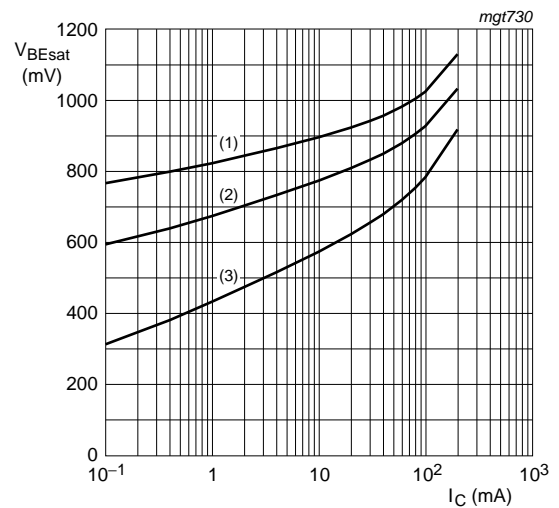
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 8. BC847BMB: Base-emitter voltage as a function of collector current; typical values**



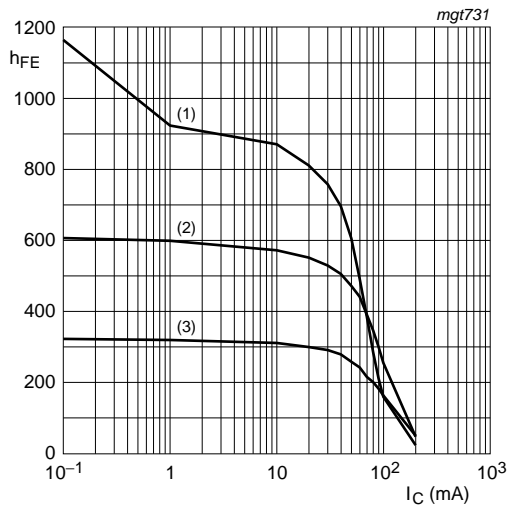
$I_C/I_B = 20$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 9. BC847BMB: Collector-emitter saturation voltage as a function of collector current; typical values**



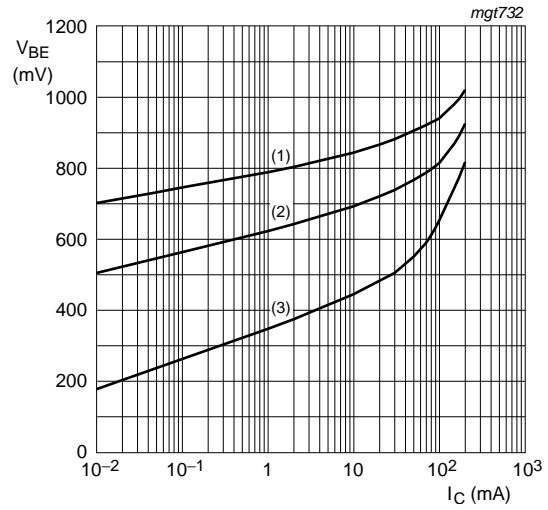
$I_C/I_B = 10$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 10. BC847BMB: Base-emitter saturation voltage as a function of collector current; typical values**



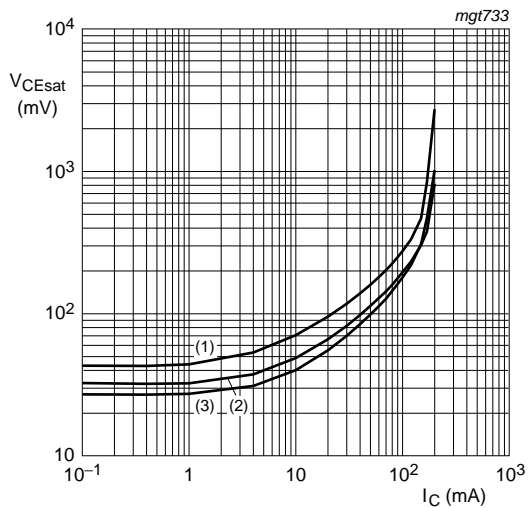
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 11. BC847CMB: DC current gain as a function of collector current; typical values**



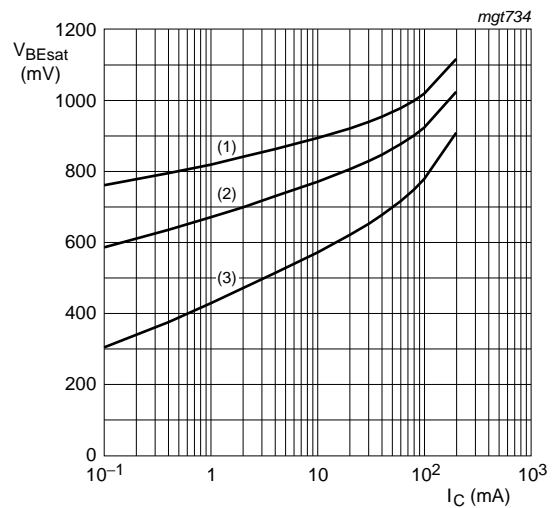
$V_{CE} = 5\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 12. BC847CMB: Base-emitter voltage as a function of collector current; typical values**



$I_C/I_B = 20$   
 (1)  $T_{amb} = 150\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig 13. BC847CMB: Collector-emitter saturation voltage as a function of collector current; typical values**



$I_C/I_B = 10$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 150\text{ °C}$

**Fig 14. BC847CMB: Base-emitter saturation voltage as a function of collector current; typical values**



## 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 9. Package outline

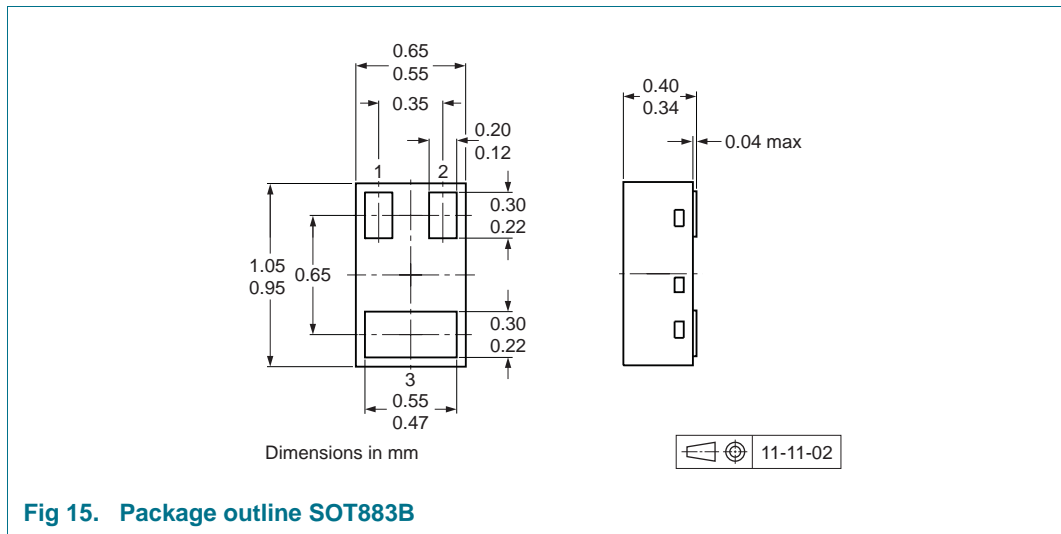


Fig 15. Package outline SOT883B

## 10. Packing information

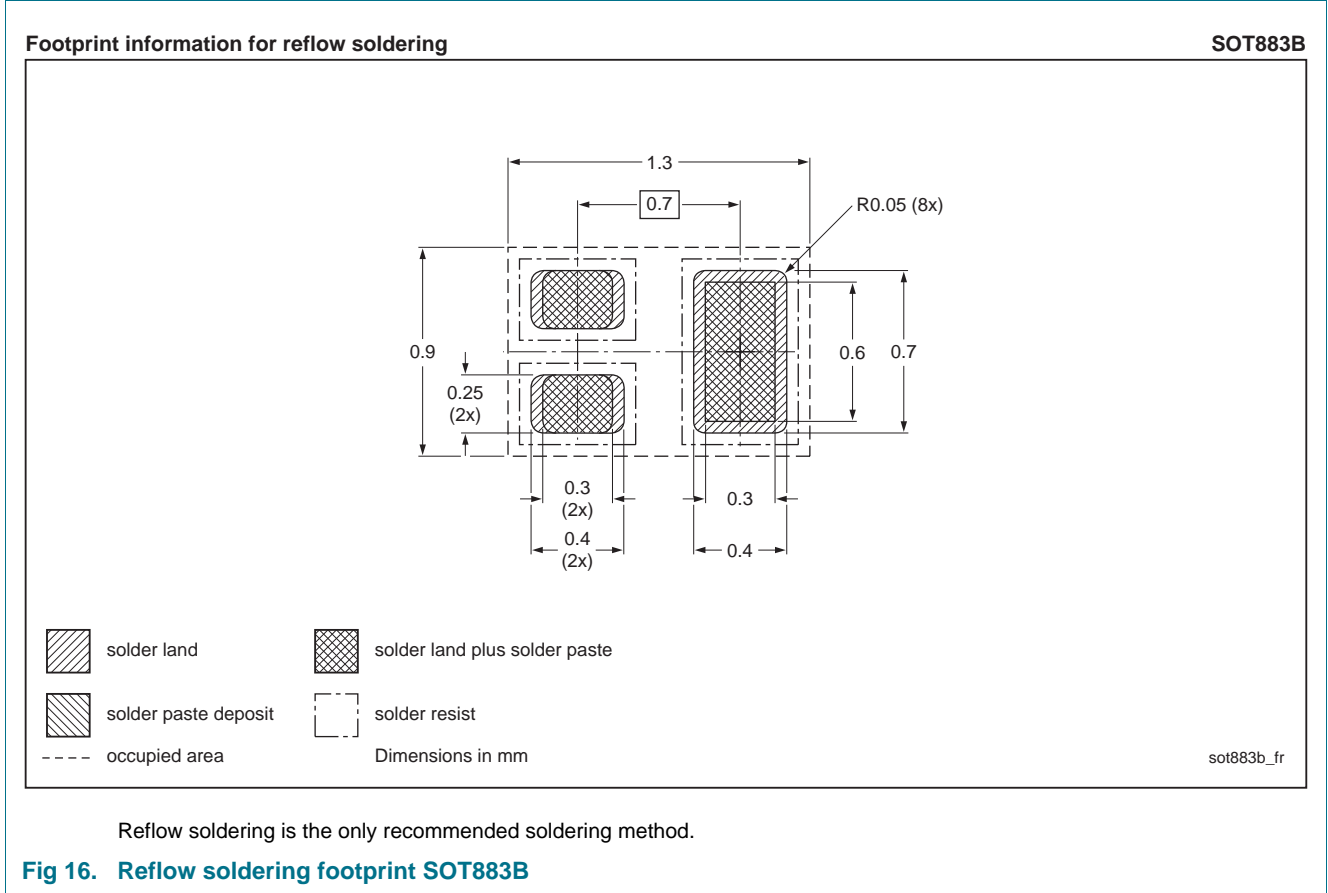
**Table 9. Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.<sup>[1]</sup>

| Type number     | Package | Description                    | Packing quantity     |
|-----------------|---------|--------------------------------|----------------------|
| BC847xMB series | SOT883B | 2 mm pitch, 8 mm tape and reel | <b>10000</b><br>-315 |

[1] For further information and the availability of packing methods, see [Section 14](#).

## 11. Soldering



## 12. Revision history

**Table 10. Revision history**

| Document ID      | Release date | Data sheet status  | Change notice | Supersedes |
|------------------|--------------|--------------------|---------------|------------|
| BC847XMB_SER v.1 | 20120305     | Product data sheet | -             | -          |

## 13. Legal information

### 13.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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## 14. Contact information

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For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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